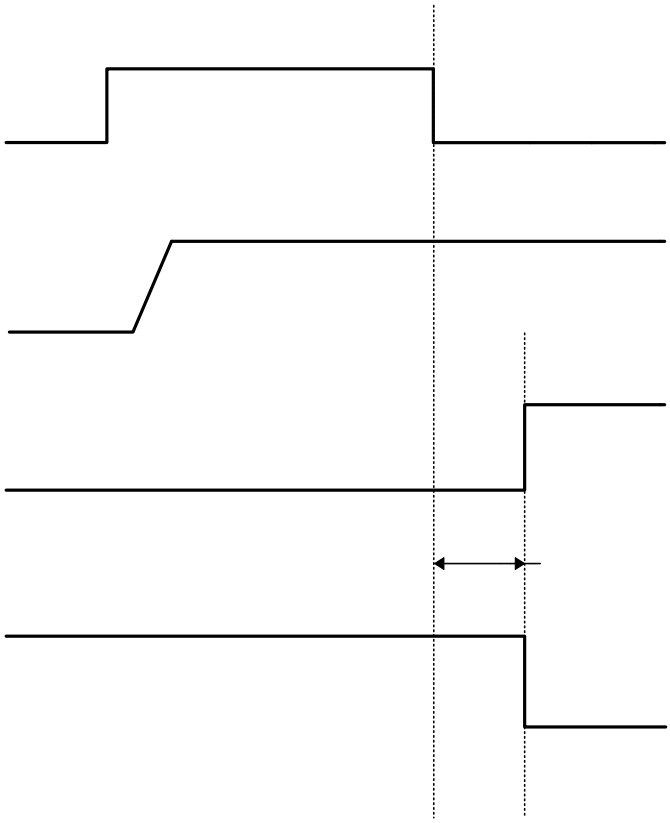
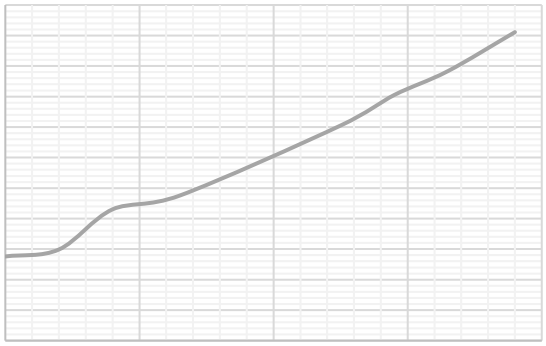
ORDERABLE DEVICE	PACKAGING TYPE	STANDARD PACK QTY	PACKAGE MARKING	PINS	PACKAGE DESCRIPTION	MSL

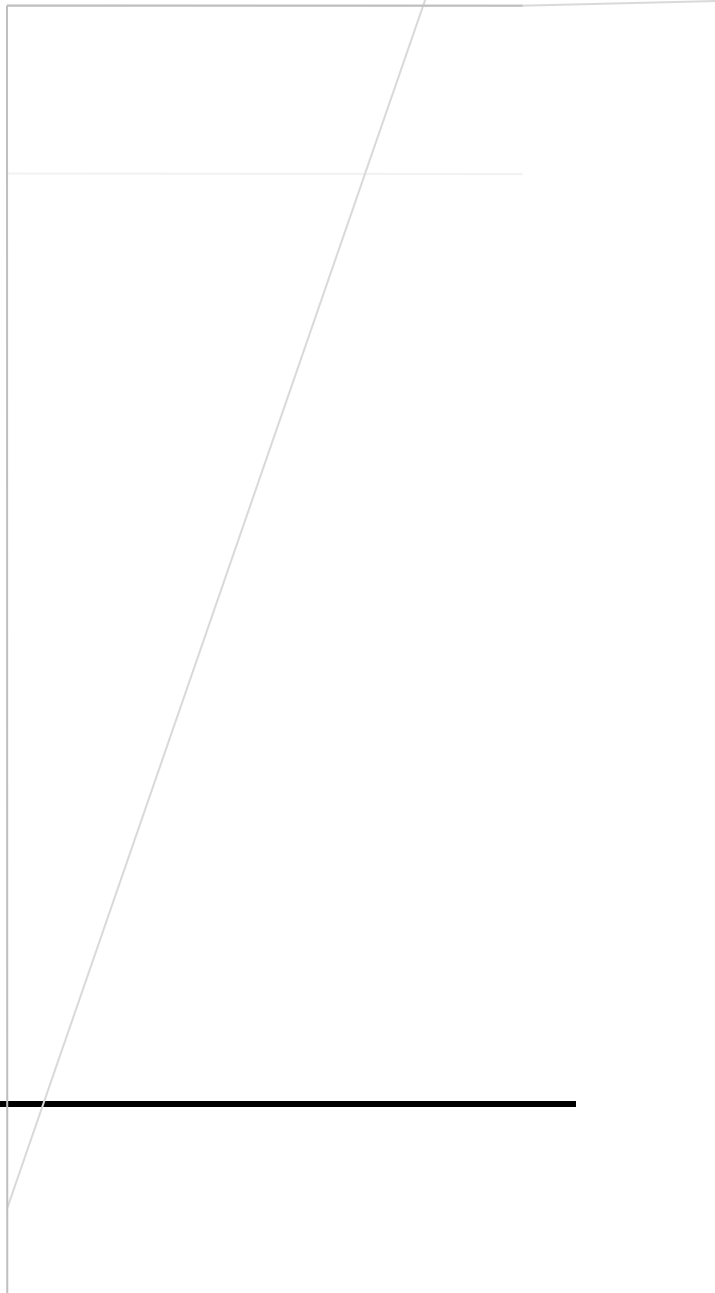
DESCRIPTION	MIN	MAX	UNIT

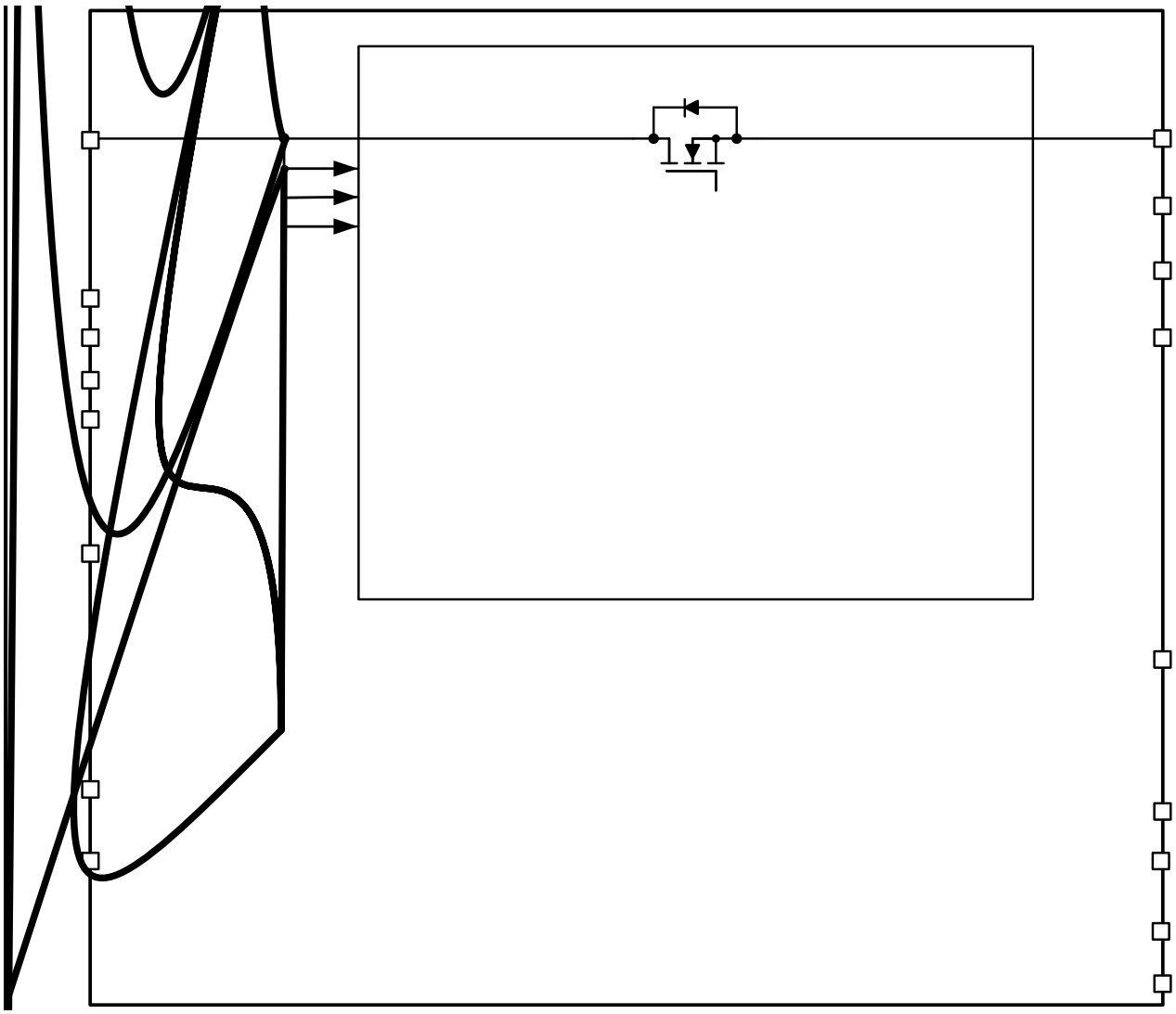
PARAMETER	THERMAL METRIC	ETSSOP-28L	UNIT

Logic Input(INx,DIAG_EN,THER,SEH,SEL)









Overview

Adjustable Current Limit

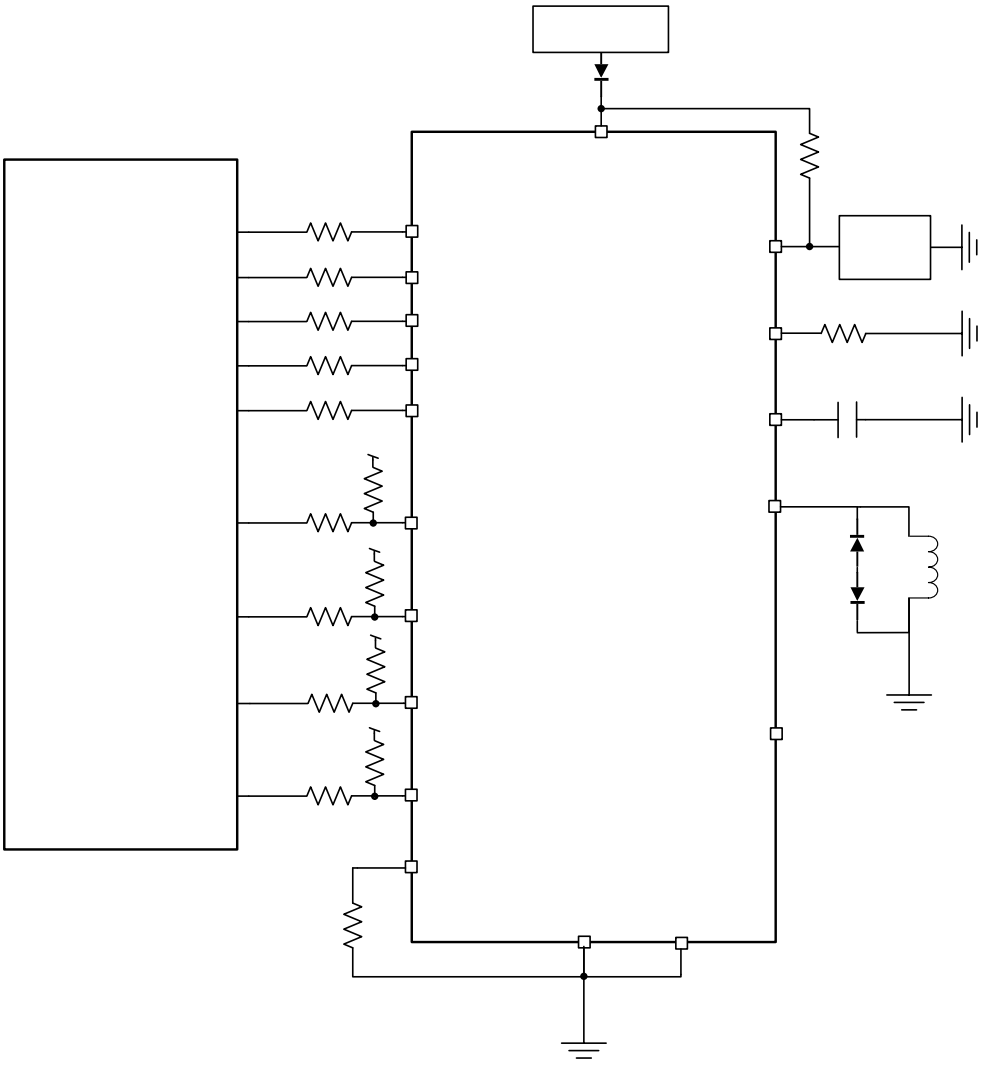
- 0.00(e)-9(l-82DC q -5(wort4 9.96 TSpan -0.0( )-10W* n Bn)-7(d)-6)3(c)-5(haUS)>> BDC gpan <</MCID 91/Lang (en-US)>>T / Fopi-5(

Accurate Current Sense

Thermal Shutdown

MCU I/O Protection

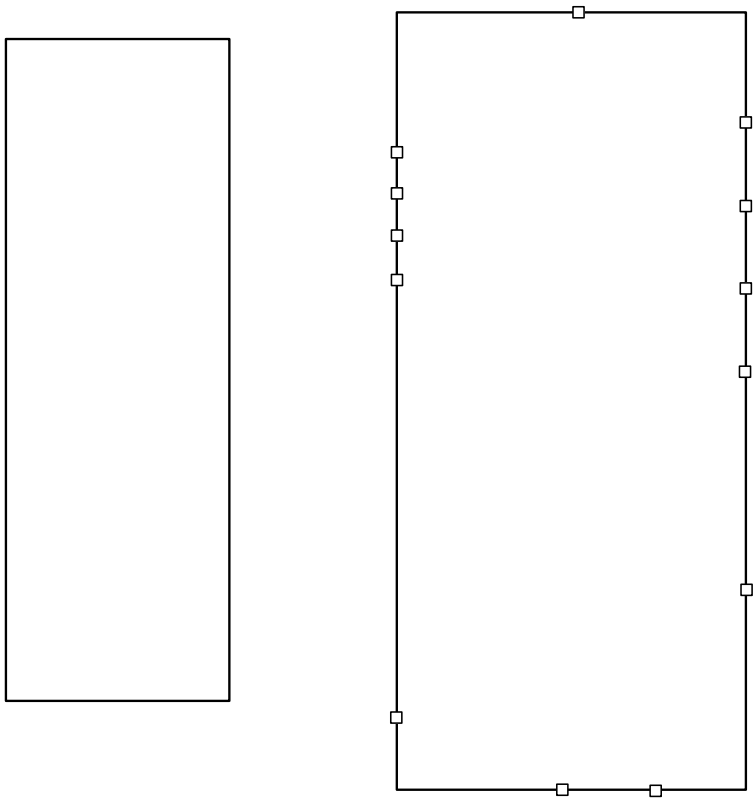
Typical Application



Design Parameters

Design Parameters

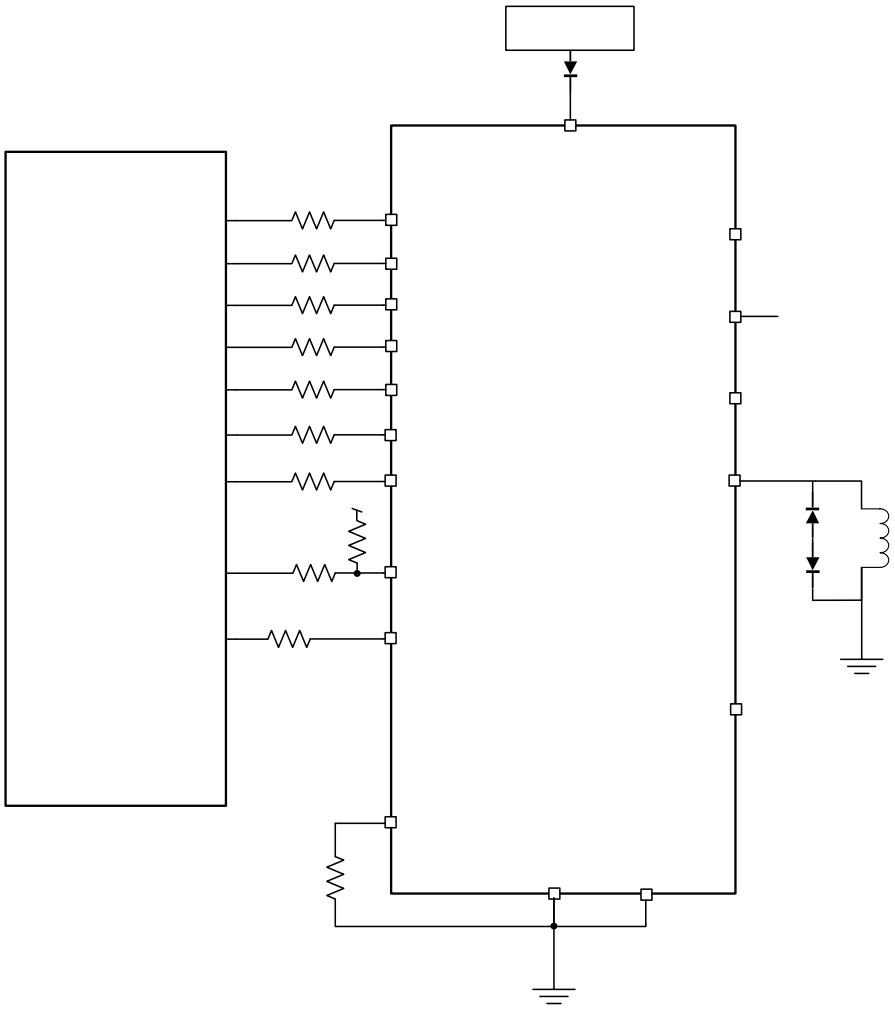
Typical Application (continued)



Design Parameters

Design Parameters	Example Value

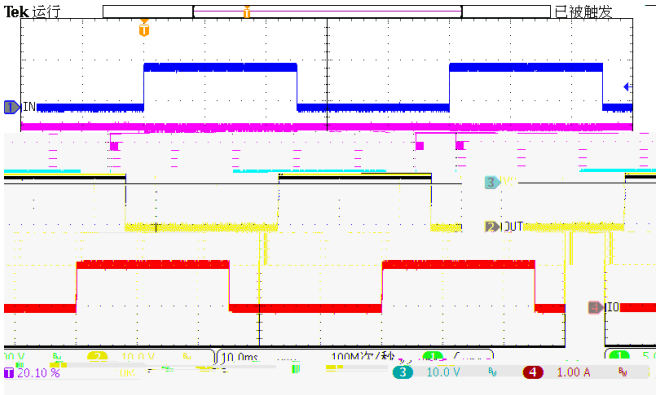
Typical Application (continued)

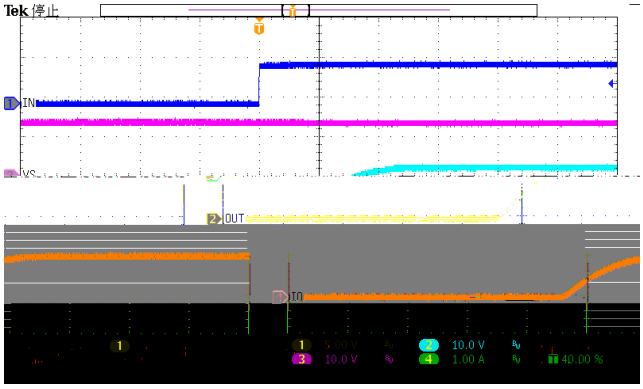


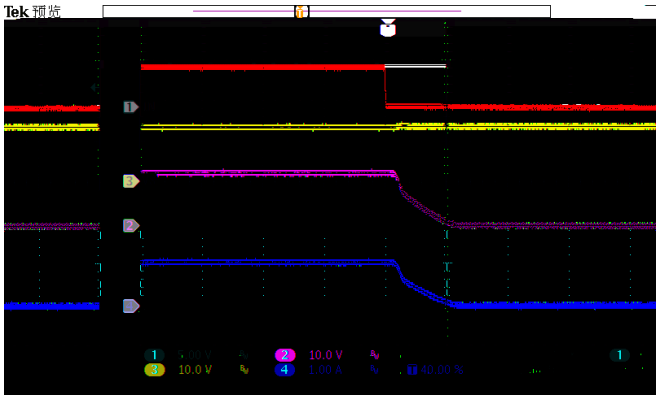
Design Parameters

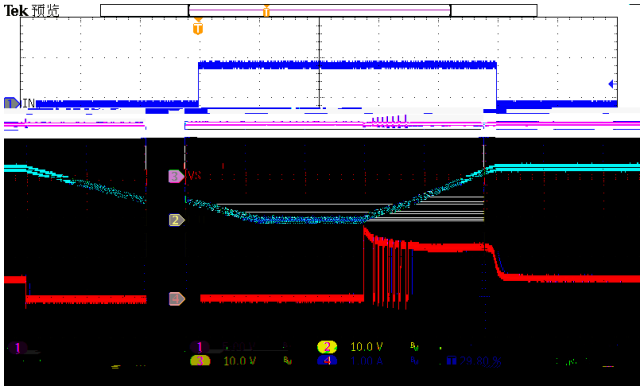
Design Parameters	Example Value

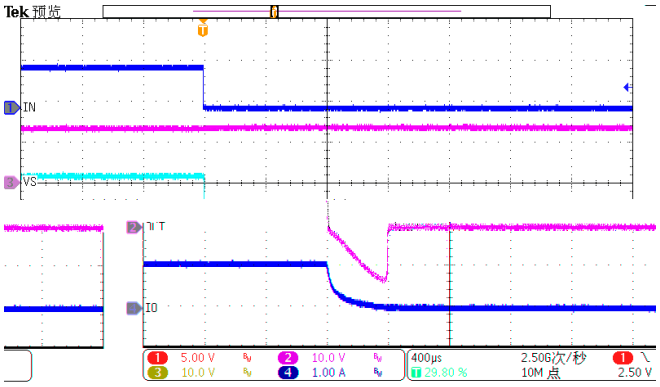
Application Waveforms

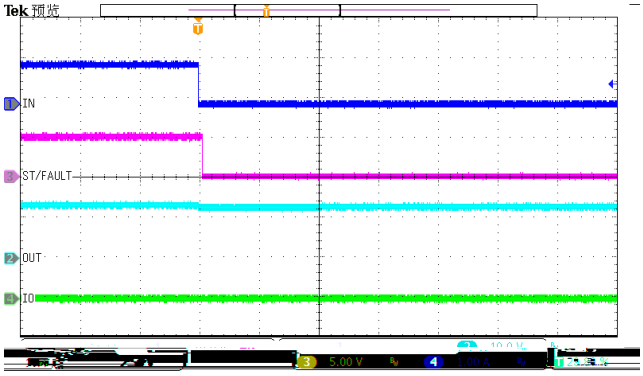




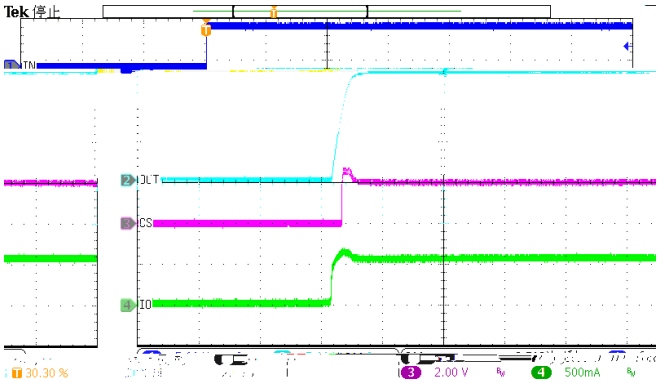


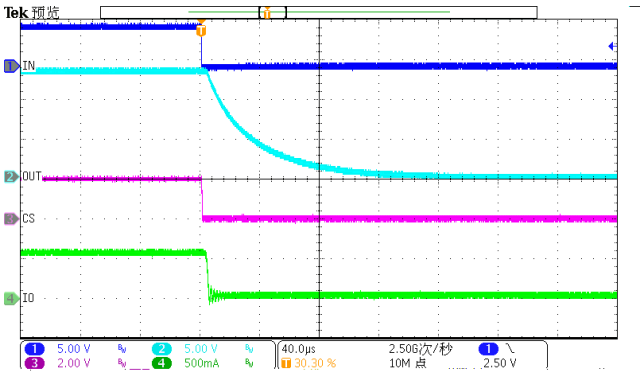


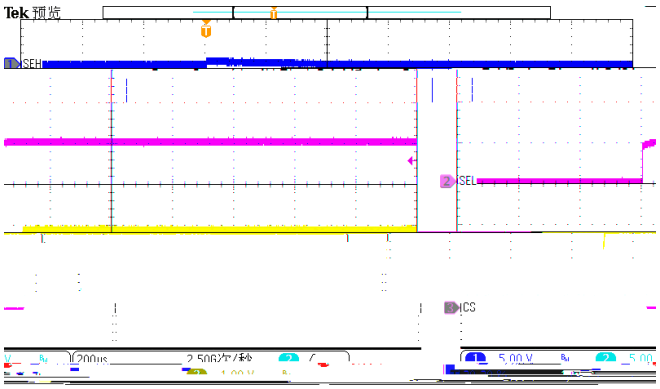


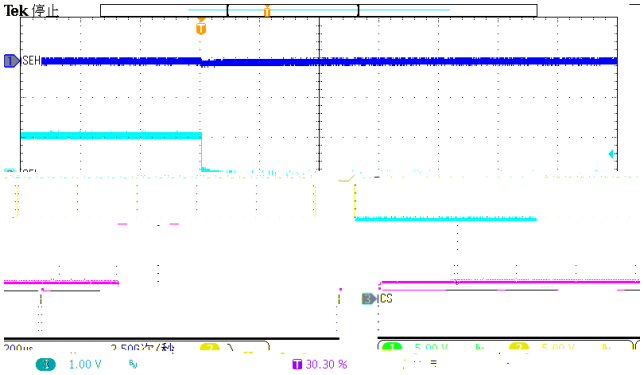


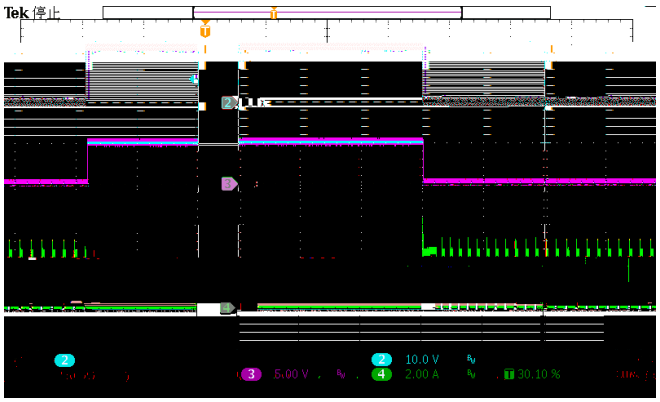
Application Waveforms(continued)

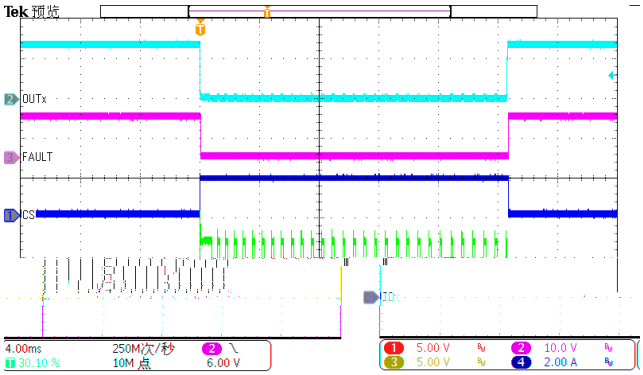




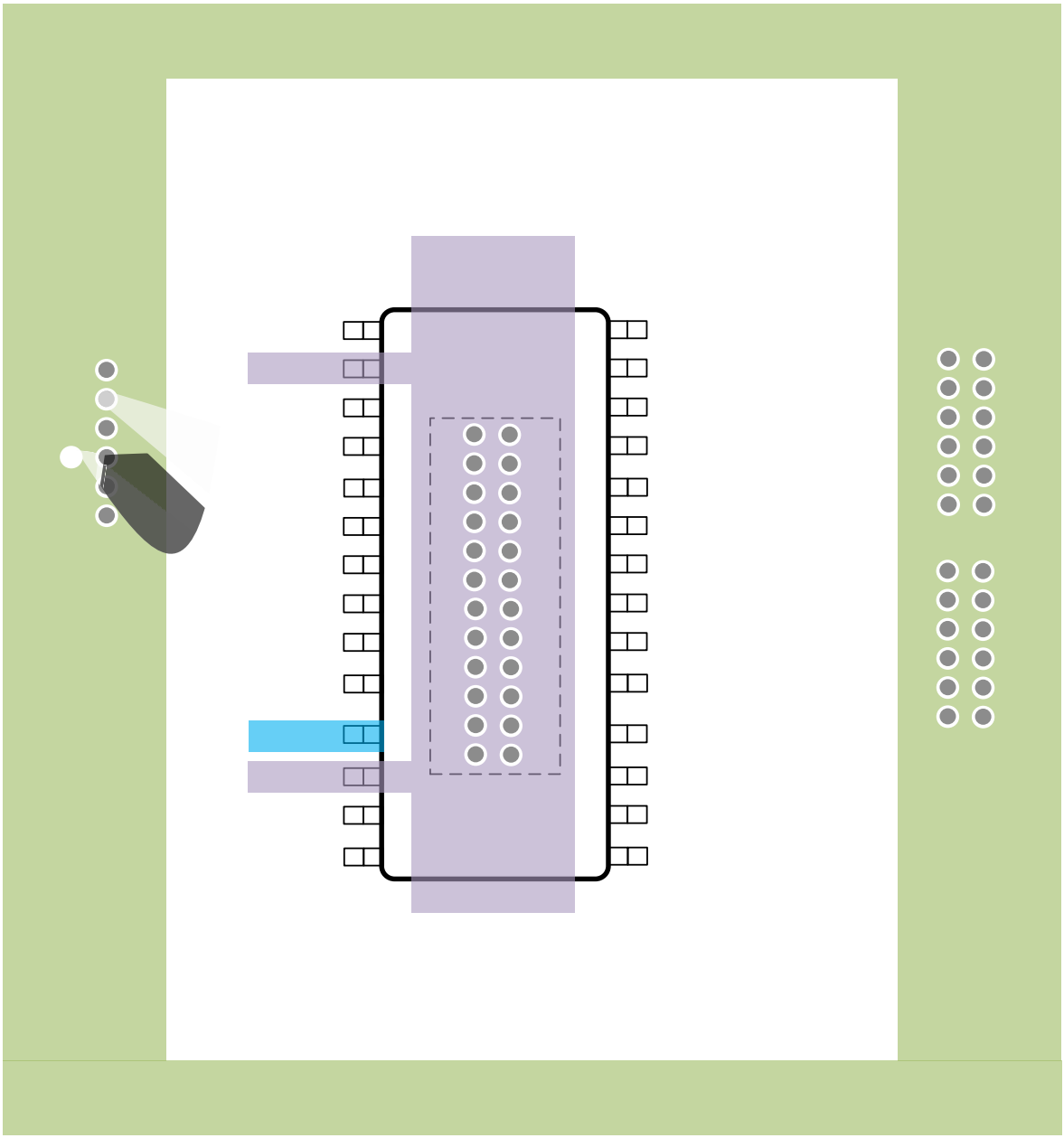


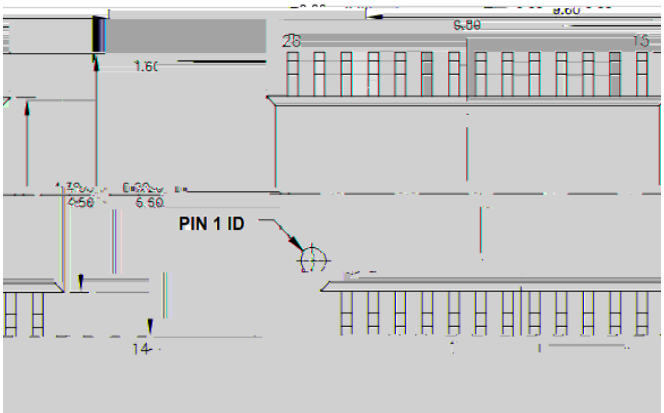


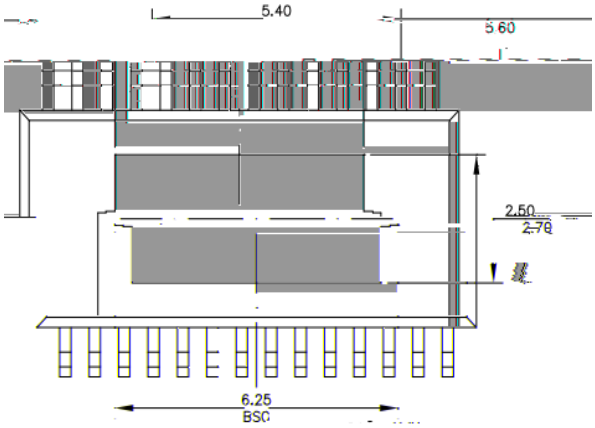




Layout Guideline







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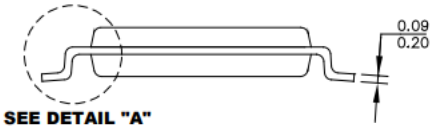

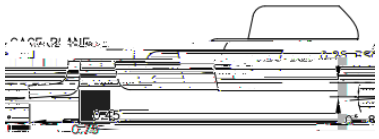

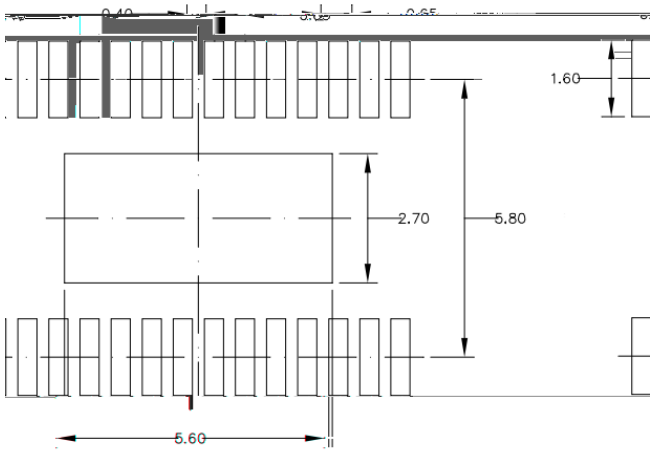

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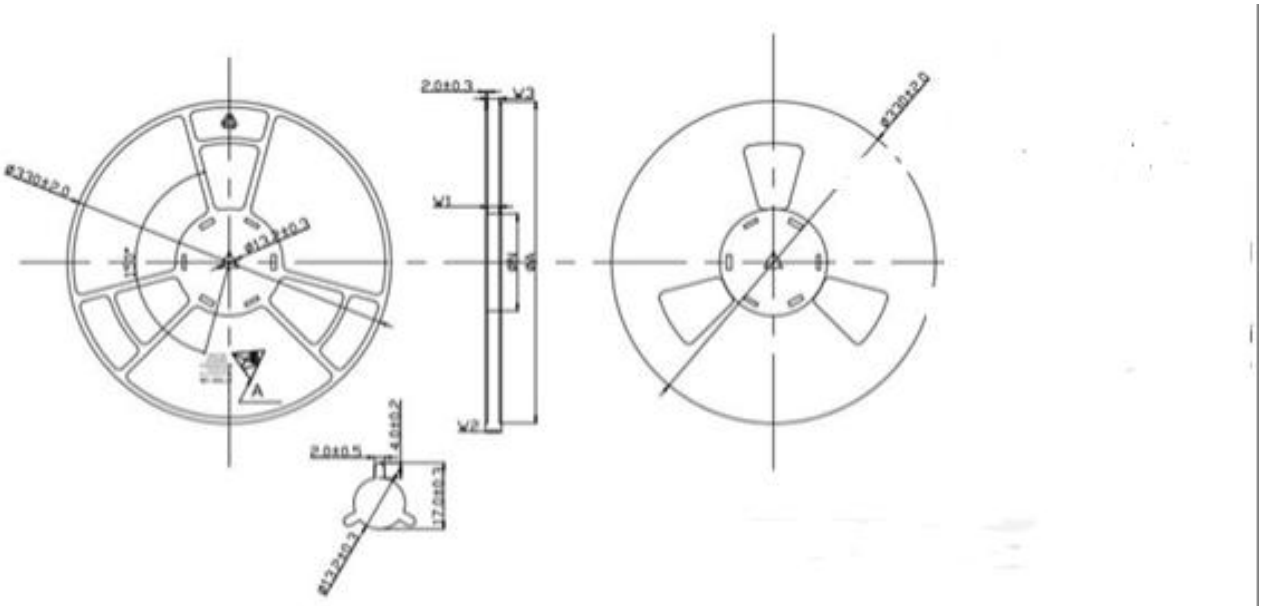
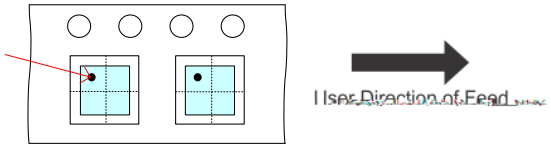
PRODUCT SPECIFICATIONS					
TYPE WIDTH	ØA	ØN	W1(+0.0)	W2(Max)	W3(Min)
16MM	330±2.0	100±1.0	16.4	22.4	15.9/19.4